Silicon Carbide Schottky Diode

V_{RRM}	=	650 V
I_F (T_C=152 ℃)	=	8 A
Q_C	=	28 nC

Features

- 650 V Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching
- Extremely Fast Switching

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- High Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switching Mode Power Supply
- Boost Diodes in PFC
- DC/DC Converters
- AC/DC Converters
- Free Wheeling Diodes in Inverter

Package

TO-220-2

Maximum Ratings （Tc = 25 ℃ unless otherwise specified）

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	650	V		
V_{RSM}	Surge Peak Reverse Voltage	650	V		
V_R	DC Peak Reverse Voltage	650	V		
I_F	Continuous Forward Current	26 11.7 8	A	T_C=25 ℃ T_C=135 ℃ T_C=152 ℃	Fig. 3
I_{FSM}	Non-Repetitive Forward Surge Current	64	A	T_C=25 ℃，t_p=10 ms，Half Sine Pulse	
P_{tot}	Power Dissipation	100 43	W	T_C=25 ℃ T_C=110 ℃	Fig. 4
T_J	Operating Junction Range	-55 to +175	℃		
T_{stg}	Storage Temperature Range	-55 to +175	℃		

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Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.38 1.8	1.65 2.4	V	I_F = 8 A， T_J = 25 °C I_F = 8 A， T_J = 175 °C	Fig. 1
I_R	Reverse Current	3 10	50 180	μA	V_R = 650 V， T_J = 25 °C V_R = 650 V， T_J = 175 °C	Fig. 2
Q_C	Total Capacitive Charge	28		nC	V_R = 400 V， I_F = 8 A， T_J = 25 °C	Fig. 6
C	Total Capacitance	540 56 42		pF	V_R = 0 V， T_J = 25 °C， f = 1 MHz V_R = 200 V， T_J = 25 °C， f = 1 MHz V_R = 400 V， T_J = 25 °C， f = 1 MHz	Fig. 5
E_C	Capacitance Stored Energy	3.7		μJ	V_R = 400 V	Fig. 7

Note：This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case		1.5		°C/W	Fig.8

Typical Performance

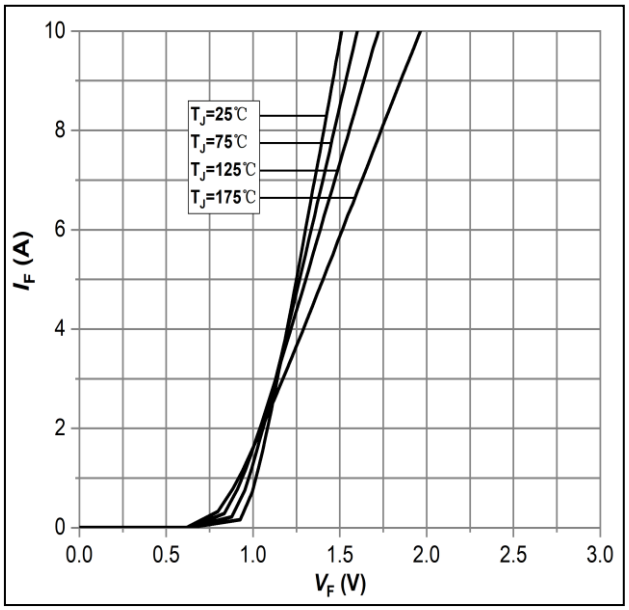

Figure 1: Forward Characteristics

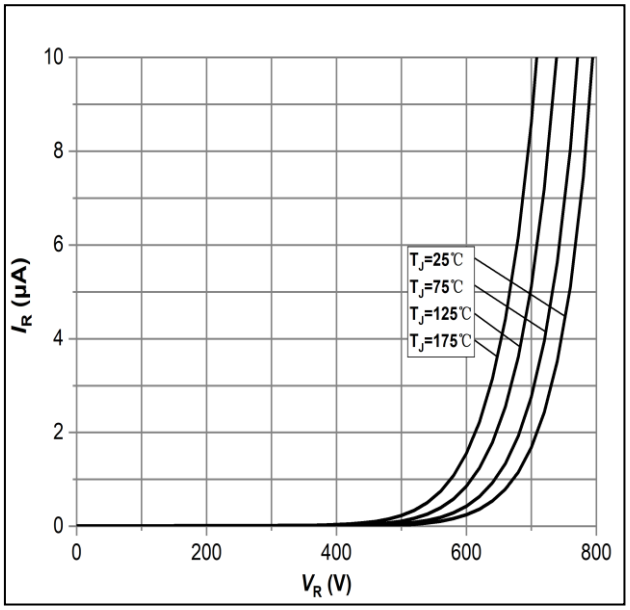

Figure 2: Reverse Characteristics

Typical Performance

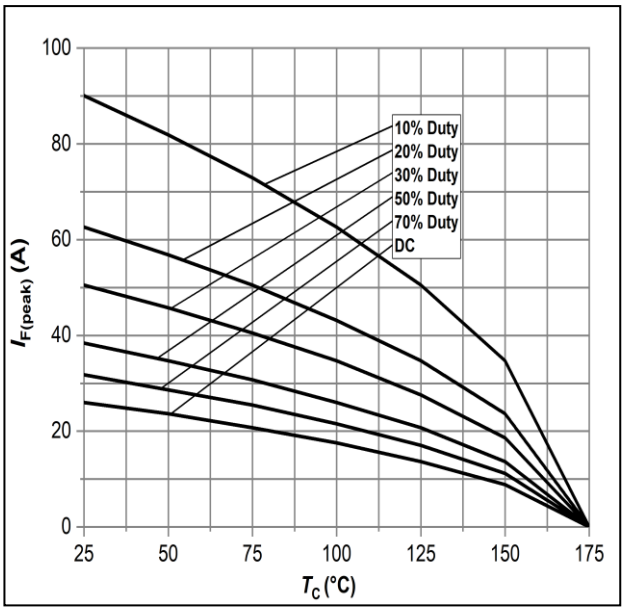

Figure 3: Current Derating

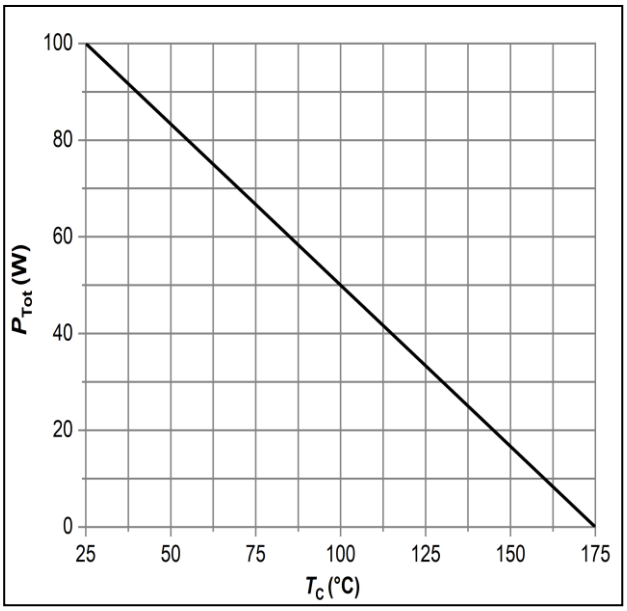

Figure 4: Power Derating

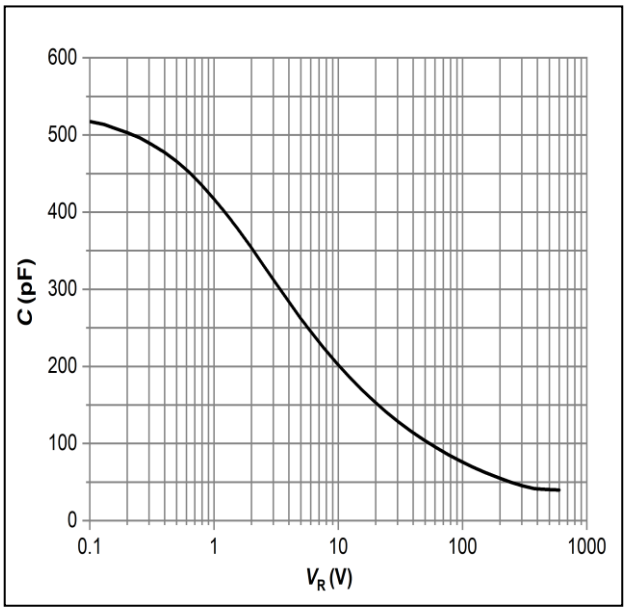

Figure 5: Capacitance vs. Reverse Voltage

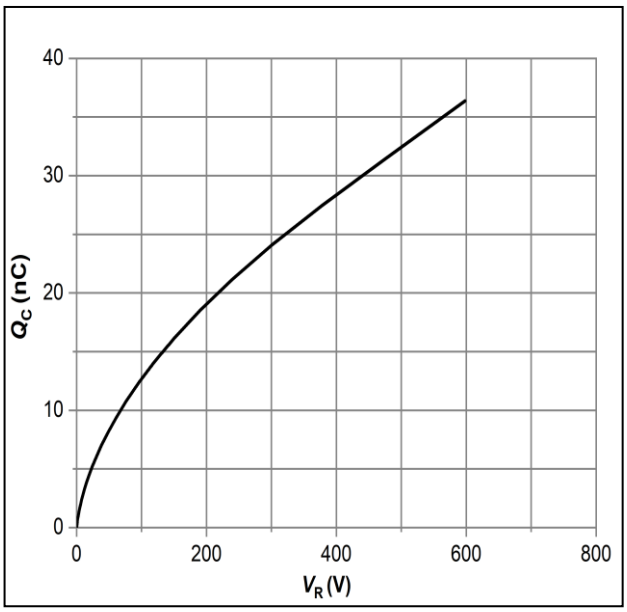

Figure 6: Total Capacitance Charge vs. Reverse Voltage

Typical Performance

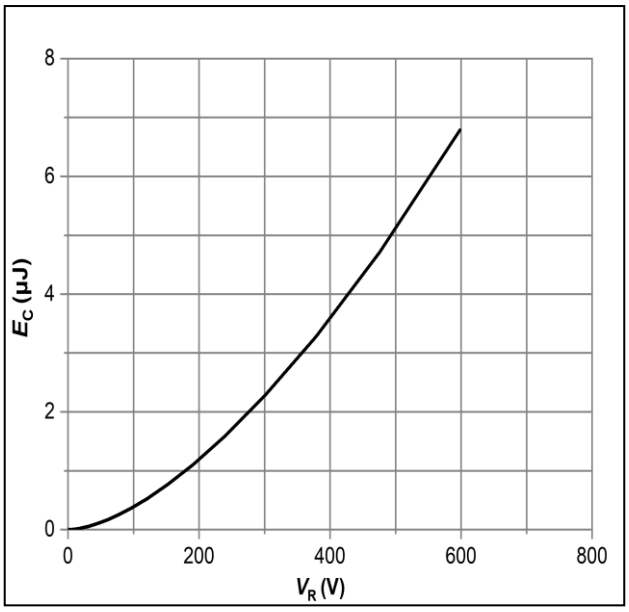

Figure 7:Typical Capacitance Stored Energy

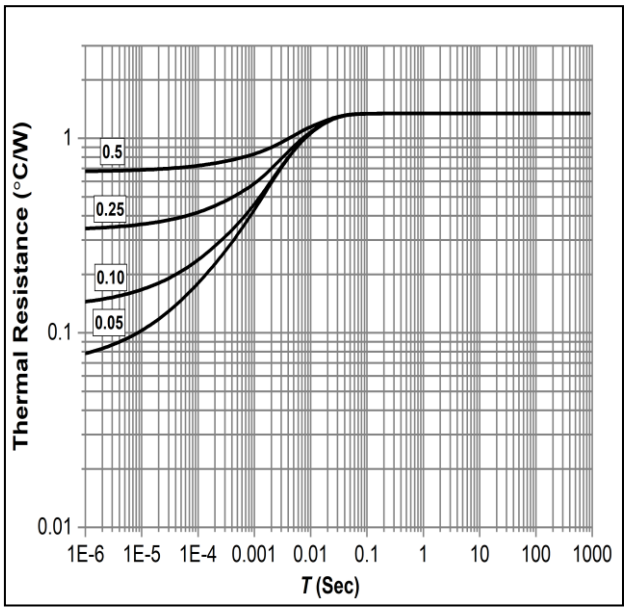

Figure 8: Transient Thermal Impedance

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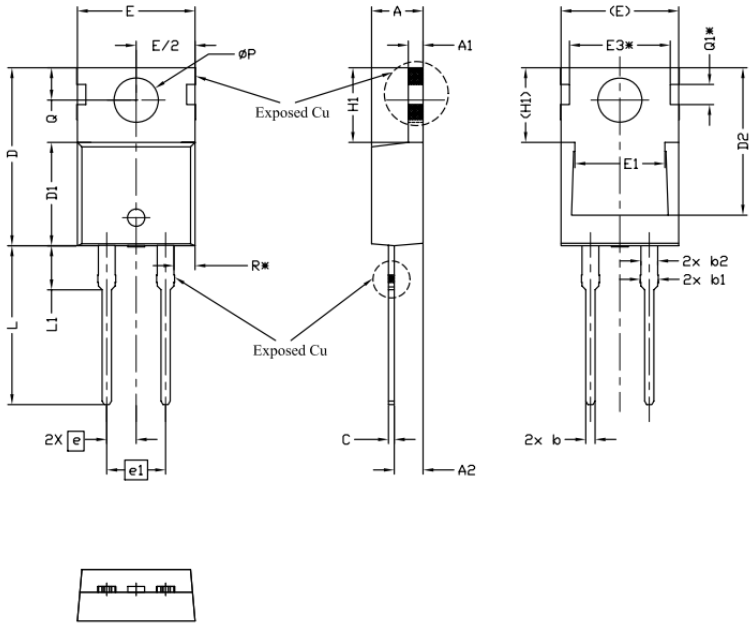
Package Dimensions

Package： TO-220-2



SYMBOL	DIMENSIONS			NOTES
	Min.	NOM	Max.	
A	4.24	4.44	4.64	
A1	1.15	1.27	1.40	
A2	2.30	2.48	2.70	
b	0.70	0.80	0.90	
b1	1.20	1.55	1.75	
b2	1.20	1.45	1.70	
c	0.40	0.50	0.60	
D	14.70	15.37	16.00	4
D1	8.82	8.92	9.02	
D2	12.43	12.73	12.83	5
E	9.96	10.16	10.36	4.5
E1	6.86	7.77	8.89	5
E3*	8.70 REF			
e	2.54 BSC			
e1	5.08 BSC			
H1	6.30	6.45	6.60	5.6
L	13.47	13.72	13.97	
L1	3.60	3.80	4.00	
ØP	3.75	3.84	3.93	
Q	2.60	2.80	3.00	
Q1*	1.73 REF			
R*	1.82 REF			

NOTE : Dimension L, M, W apply for Solder Dip Finish